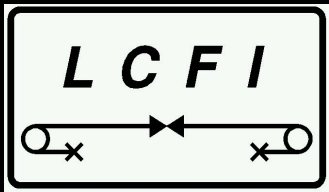
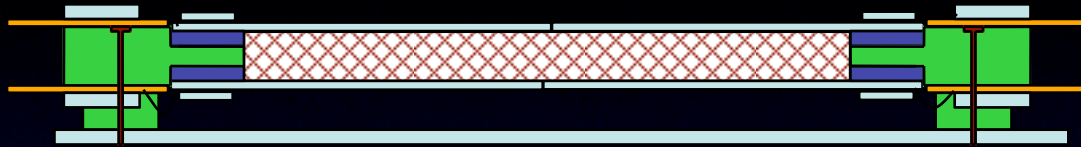


Mechanical Studies

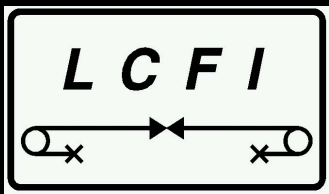
1. Research and develop mechanical support technologies
2. Research and develop module production methods
3. Produce detector global design
4. Study thermal and cooling aspects
 - *Feed back in to each other*
 - *Lead to full engineering design*



Technology R&D



- Focus on RVC and SiC foam “ladders”
 - ▶ Attached to dissimilar bulkheads
- Other ladder options considered
 - ▶ Unsupported and beryllium rejected
 - ▶ Carbon fibre less promising than foams
- Look for novel solutions



Integral Structures

- **Carbon Fibre Shells**

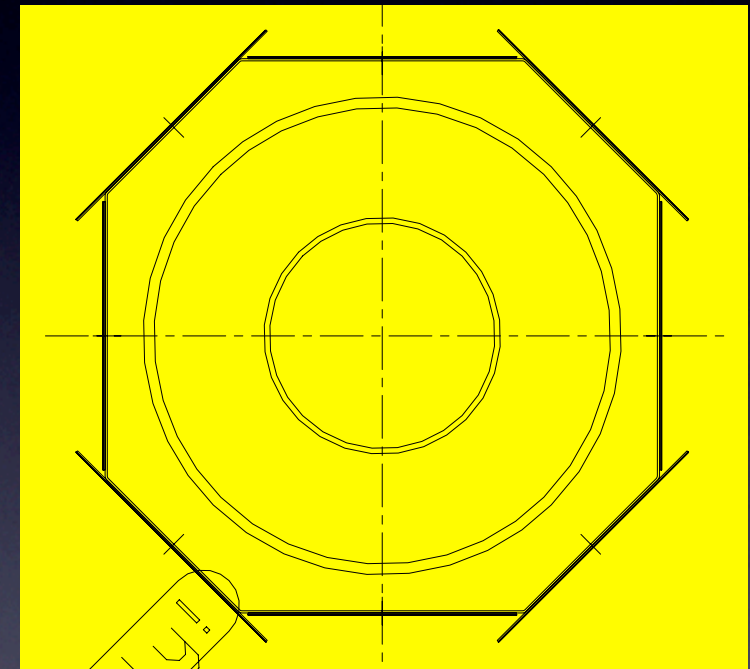
- ▶ Expertise at Liverpool (CDF Layer00)
- ▶ Good results with 2-ply weave
- ▶ Lower-mass material being sourced

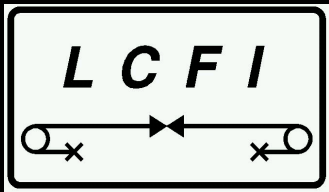
- **SiC Foam**

- ▶ SiC ladders glued to SiC bulkheads
- ▶ Eliminate differential CTE

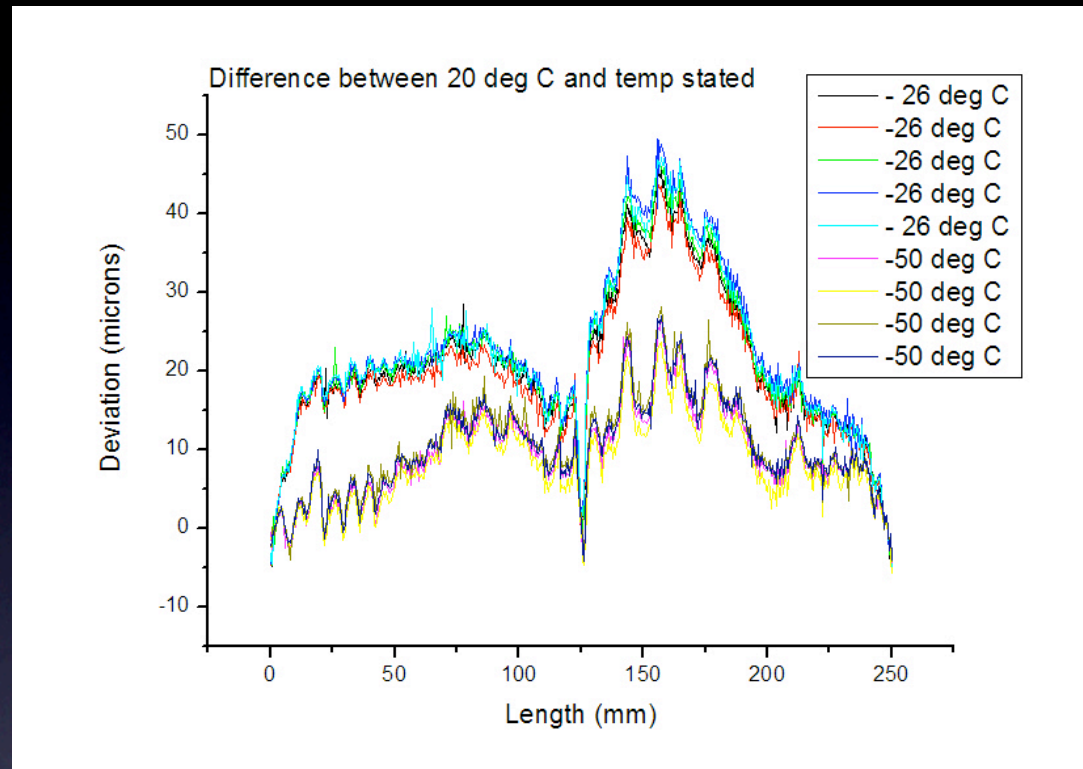
- **All Silicon**

- ▶ “Thick” sensors glued along long edge
- ▶ Collaborating with FNAL and Washington

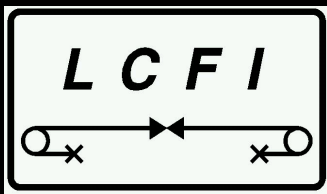




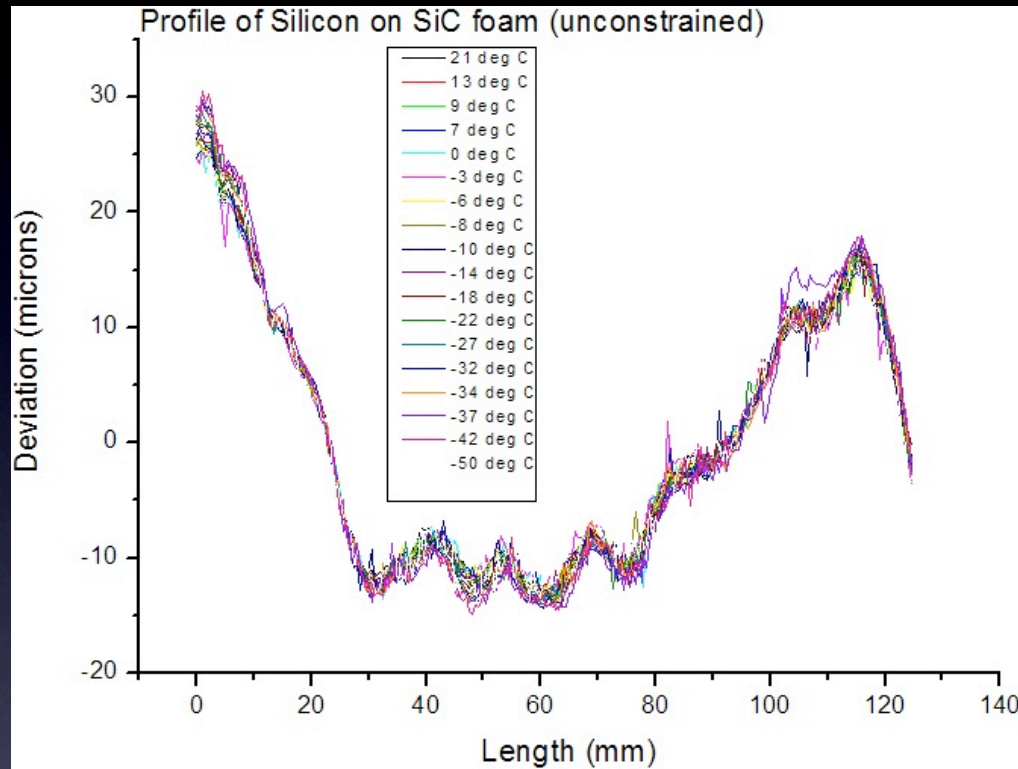
RVC Ladder



- Surveyed by laser
 - ▶ Highly reproducible results
 - ▶ Ladder deviation less than 50 microns
- Ultimate quality limited by fixtures

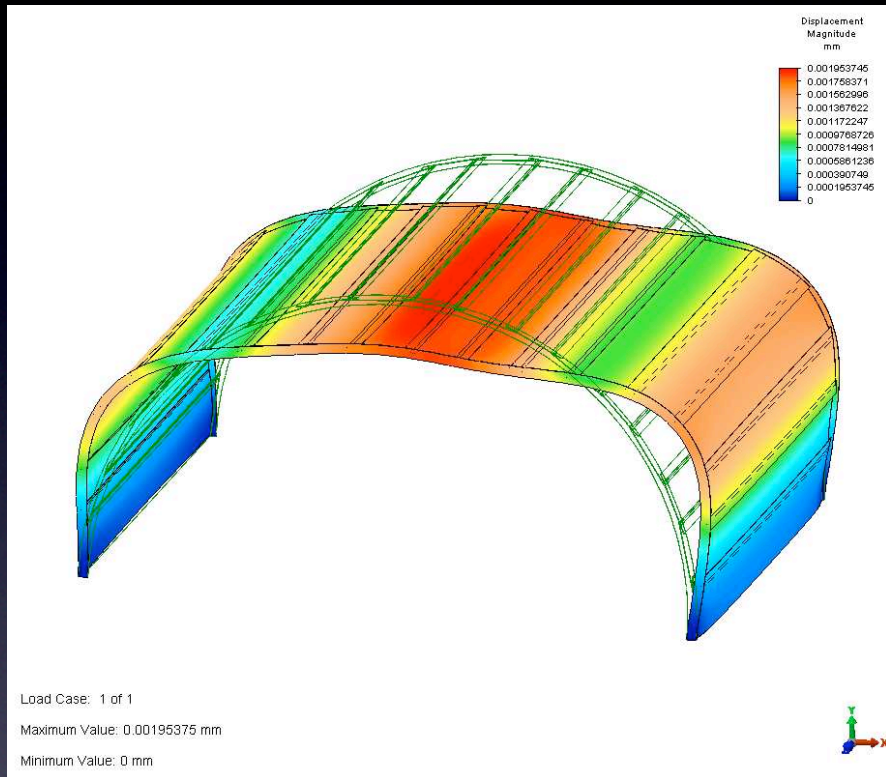


SiC Foam Ladder



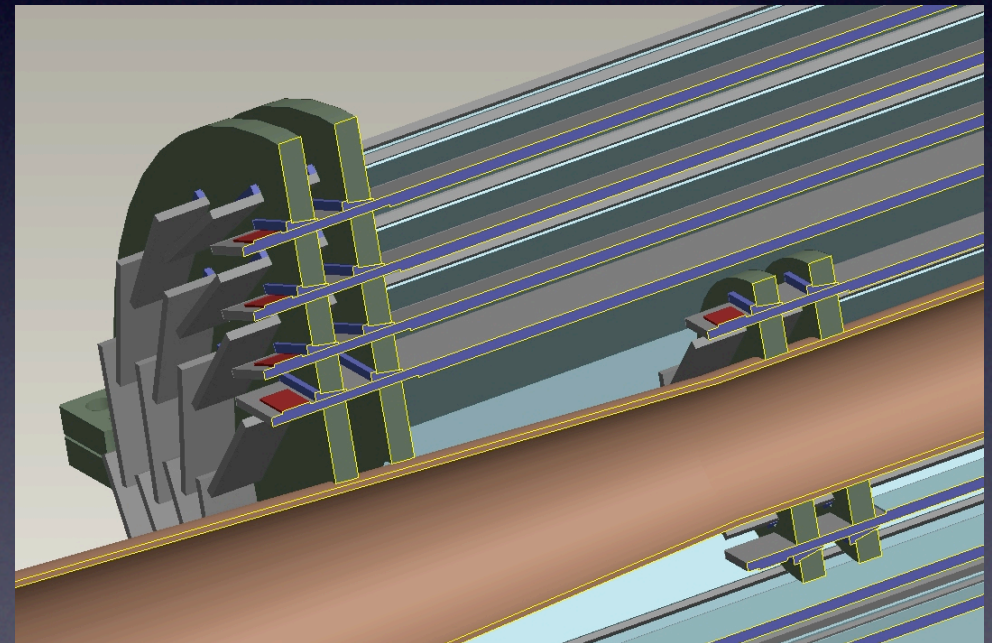
- **Processed SiC Foam**
 - ▶ A fraction of initial shape left
 - ▶ 30% over material budget
- **Minimally constrained**
 - ▶ Eliminate stiction in mountings

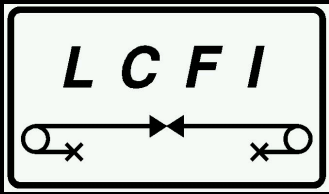
Negligible deformation over 70 degrees!



FEA model of all silicon structure

Preliminary design of integral SiC foam structure

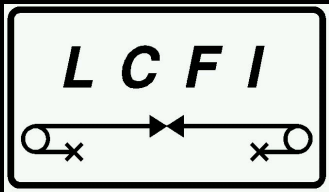




Production R&D



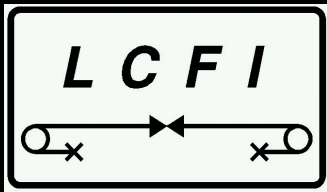
- Thinned blank silicon from Aptek Inc
 - ▶ Approximately 20 microns thick
 - ▶ High yield, reasonably priced
- SiC Foam Production and Metrology
 - ▶ Successful tests of grinding with UK company
 - ▶ Promising for thinning below 1.5mm
 - ▶ Measure flatness with large, low-force touch probe
- New general-purpose fixturing developed
 - ▶ Ceramic foam vacuum chucks tested



Global Issues



- Studying cable forces
 - ▶ May dominate in all silicon design
 - ▶ Developing techniques for FEA
- Begun discussion of alignment
 - ▶ Need improvements in software
 - ▶ Required overlap will influence geometry
 - ▶ Techniques for cold survey during assembly
 - ▶ etc...



Future Plans



- Processing of SiC foam
 - ▶ Minimum thickness
 - ▶ Shaping
- Low mass carbon-fibre weave
- New fixtures for ladder assembly
- FEA/benchtop studies of cable forces
- Baseline integral SiC foam design
- Start to answer alignment questions